

Session Program

26-30 Sept 2011

TWEPP 2011 Topical Workshop on Electronics for Particle Physics

A5a - Packaging and Interconnects

Vienna, Austria

Vienna University of Technology Department of Electrical
Engineering Gusshausstraße 27-29 1040 Vienna, Austria

Thursday 29 September

09:50

A5a - Packaging and Interconnects

Session |

Location: Vienna, Austria, Room EI 7, **Vienna University of Technology**

Department: Institute of Microelectronics Engineering Gusshausstraße 27-29 1040 Vienna, Austria |

09:50-10:15

Microfluidic cooling for detectors and electronics

Speaker

Paolo Petagna

10:15-10:40

Progress on a Si-W ECAL Detection and Readout Interconnects

Speaker

Mr Michael Woods

10:40